

Thin-Film Filters

50Ω DC to 40 GHz

THE BIG DEAL

- Low Passband Insertion Loss
- High Rejection
- Good Power Handling
- Temperature Stability -55°C to 125°C
- High Repeatability
- RoHS Complaint
- Small Size



PRODUCT OVERVIEW

Mini-Circuits' Surface Mount Thin-Film filters offer low insertion loss and high rejection realized via Thin-Film on Alumina substrate, using a sputtering process that can guarantee an enhanced Q and repeatable performance. Low pass, high pass, and bandpass surface mount thin-film designs can be realized with this technology up to 40 GHz in a small form factor helping customers achieve their SWaP objectives. Using our high quality thin-film manufacturing process we can guarantee repeatability on large batches of filters.

KEY FEATURES

Feature	Advantages		
Low insertion loss	High Q material and sputtering process results in lower insertion loss, better SNR is obtained.		
Fast roll-off (steeper skirts)	Higher selectivity results in better adjacent channel rejection and dynamic range		
Wider stopband	Wide spur-free stopband results in better adjacent channel rejection and dynamic range		
Temperature stability	Very minimal change in electrical performance across temperature makes these filters suitable for a wide range of operating conditions.		
Small Size	Various design techniques are employed to realize small size.		

REV. OR ECO-015961 ABF-10R125G+ EDU4338 URJ 221202





Bandpass Filter

50Ω 9.35 to 10.9 GHz

ABF-10R125G+

FEATURES

- Low Passband Insertion Loss of 1dB Typ.
- · High Rejection of 57dB Typ.
- Good Return Loss of 11dB Typ.
- Small Size, 5.59 x 8.13 x 2.03 mm

APPLICATIONS

- X-Band Radar
- Terrertial Communication Systems
- · Aerospace and Defense Signal Conditioning
- · Test and Measurement Equipment



Generic photo used for illustration purposes only

CASE STYLE: UC2731

+RoHS Compliant

The +Suffix identifies RoHS Compliance.
See our website for methodologies and qualification

ELECTRICAL SPECIFICATIONS¹ AT 25°C

Paran	neter	F#	Frequency (MHz)	Min.	Тур.	Max.	Units
Pass Band	Insertion Loss	F1-F2	9350 - 10900	_	1.0	2.5	dB
	Return Loss	F1-F2	9350 - 10900	_	11	_	dB
Stop Band, Lower	Rejection	DC-F3	DC - 6000	40	57	_	dB
		F3-F4	6000 - 7500	20	38	_	ав
		F5-F6	13000 - 15500	20	44	_	
Stop Band, Upper	Rejection	F6-F7	15500 - 18000	40	53	_	dB
		F7-F8	18000 - 23000	_	30	_	

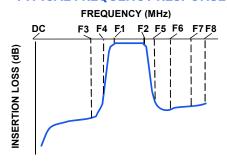
^{1.} Measured on Mini-Circuits Characterization Test Board TB-ABF-10R125G+ with feedline losses removed by normalization of S12 and S21 traces to mesurement of TB thru-line.

ABSOLUTE MAXIMUM RATINGS

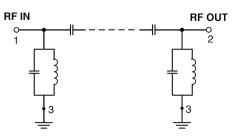
Parameter	Ratings
Operating temperature	-55°C to +125°C
Storage temperature	-55°C to +125°C
RF Power Input at Passband	1W Max. at 25°C

Permanent damage may occur if any of these limits are exceeded.

TYPICAL FREQUENCY RESPONSE



FUNCTIONAL DIAGRAM





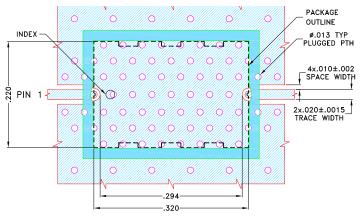
Bandpass Filter

ABF-10R125G+

PAD CONNECTIONS

RF IN	1
RF OUT	2
GROUND	3

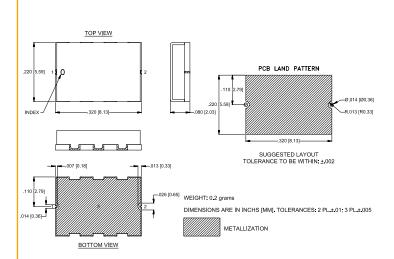
DEMO BOARD MCL P/N: TB-ABF-10R125G+ **SUGGESTED PCB LAYOUT** (PL-652)



NOTES:

- COPLANAR WAVEGUIDE PARAMETERS ARE SHOWN FOR ROGERS (R04350B) WITH DIELECTRIC THICKNESS .010±.0010. COPPER: 1/2 Oz. EACH SIDE.
 FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED.
- 2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.
- DENOTES PCB COPPER PATTERN WITH SMOBC (SOLDER MASK OVER BARE COPPER)
 DENOTES PCB COPPER PATTERN FREE OF SOLDERMASK

OUTLINE DRAWING



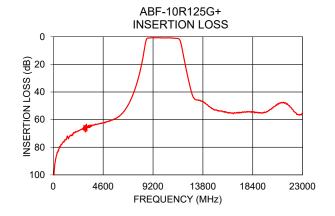


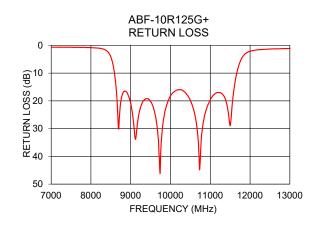
Bandpass Filter

ABF-10R125G+

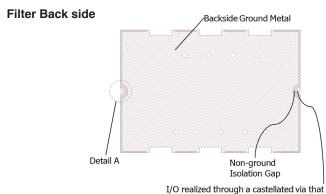
TYPICAL PERFORMANCE DATA AT 25°C

Frequency (MHz)	Insertion Loss (dB)	Return Loss (dB)
10	118.86	0.03
1000	76.06	0.18
6000	57.79	0.60
7500	38.74	0.68
8100	21.76	0.91
9350	0.79	19.54
10000	0.79	18.24
10125	0.86	16.39
11250	1.17	17.03
10900	0.92	23.09
12200	21.31	1.59
13000	44.69	1.12
15500	53.76	1.18
18000	54.32	1.27
23000	55.15	1.44





Recommended PCB Layout Pattern for Filter



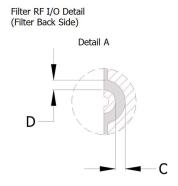
mates directly to I/O pad on top of test board PCB

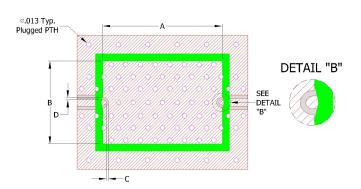


Bandpass Filter

ABF-10R125G+

PCB Pattern Recommendations



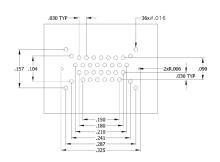


- 1) Customer PCB's ground pattern length (dimension A) can be similar to filter length.
- 2) Customer PCB's ground pattern width (dimension B) can be similar filter width.
- 3) Dimensions C and D on Filter RF I/O detail and Customer PCB pattern can be closely match. The dimensions of C and D on the Customer PCB pattern can be slightly larger to account for component alignment tolerance (ground metal can be pulled back from RF I/O trace).
- 4) Recommend to use Solder mask at Customer PCB at outer area of filter pattern/ footprint with a clearance of about 1.25mil at each side. (Tighter registration tolerance required for solder mask)
- 5) Recommended to use Solder mask at I/O of Customer PCB as per above diagram (refer detail B).

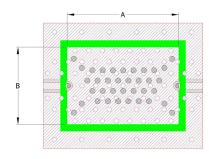
Comments on component handling and solder attach

- 1) Avoid using soldering iron directly to the ceramic filter. This would lead to development of crack in the component due to thermal shock.
- 2) Vacuum pick-up tool or plastic tweezers are recommended for handling the components. Extra care should be taken not to scratch the filter or metal area.
- 3) Use 2-3 mil thickness stencil plate and screen print the solder. Refer below picture for recommended stencil pattern to get the best solder attachment.

Stencil opening drawing



Solder location after screen print



- 4) Plugged ground vias in the PWB will improve attachment consistency.
- 5) Recommended to have a similar or closer test board material and thickness (refer Mini-Circuits evaluation board for details) to minimize the CTE over the temperature range.

NOTES

- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
- B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
- C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the standard. Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/MCLStore/terms.isp

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Mini-Circuits:

ABF-10R125G+